

**Section** \_\_\_\_\_

HV Multifunction

**Application** \_\_\_\_\_

Field  
Laboratory  
Production



**PRODUCT BENEFITS**

No silicone  
Ball bearings for an easier rotation of the tool  
Low roughness over insulation

**TOOL CAPACITY**

<b>Diameter</b>	55 - 160 mm 2,165 - 6,299 inch
<b>Bonded semicon thickness capacity</b>	3 mm / 0,118 in
<b>Remaining length of the semicon</b>	80 mm / 3,150 in
<b>Insulation thickness capacity</b>	35 mm / 1,378 in
<b>Guiding</b>	By ball bearings

**TOOL DIMENSIONS**

<b>Length</b>	700 mm
<b>Width</b>	255 mm
<b>Height</b>	180 mm
<b>Weight without box</b>	9,5 Kg
<b>Packaging</b>	Case

**ALROC SAS**

Z.I. de la Fonderie - 72160 TUFFE  
FRANCE  
Phone: +33 2 43 71 11 80  
Fax number : +33 2 43 71 16 51  
www.alroc.fr

## Multifunction tool for bonded semiconductor and insulation

**TO DO WHAT**

The CAMF5-55-160 BBCF enables the user to :

- remove the bonded semiconductor
- remove the insulation

Bonded semiconductor removal : very steady (16 ball bearings around the cable), shaping the cable round over the insulation, constant diameter over the insulation, prevent the blade from digging into the insulation

Insulation removal : back-iron that enables the user to tune the pitch of the tool thus making the rotation of the tool easy when removing the insulation



**Options**

- K7/PNS - Blade support to make groove into the insulation
- K7/GNS - Blade support to remove outer sheath semiconductor layer
- K7/RNS - Midspan insulation blade support removal
- ET-AMF5-220V - Tool motorisation
- BMFD/50-160 - Thrust to stop the tool

**Spare part**

- LFNS - Spare blade for bonded semiconductor
- LINS - Spare blade for insulation

**Associated tool**

- DMSR/80-160 - HV cable outer sheath stripping tool
- CHN4/50-110 NS - Tool to taper XLPE insulation
- GRI-RTE - Scraper for residues of bonded semiconductor screen with protective case

HV cables Tools

# CAMF5/55-160-BBCF



Part Number	Diameter	Tool capacity				Dimensions			Packaging
		Bonded semicon thickness capacity	Remaining length of the semicon	Insulation thickness capacity	Guiding	Length	Width	Height	
<b>CAMF4/40-90-BBCF</b>	40 - 90 mm 1,575 - 3,543 in	2,5 mm / 0,098 in	55 mm / 2,165 in	35 mm / 1,378 in	By ball bearings	460 mm 18,110 in	155 mm 6,102 in	150 mm 5,906 in	case
<b>CAMF5/55-160-BBCF</b>	55 - 160 mm 2,165 - 6,299 in	3 mm / 0,118 in	80 mm / 3,150 in	35 mm / 1,378 in	By ball bearings	700 mm 27,559 in	255 mm 10,039 in	180 mm 7,087 in	case